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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/519,251	12/22/2004	Ho Sung Kim	5760-2	2922
	7590 09/05/2008 EMHARDT, MORIARTY, MCNETT & HENRY LLP		EXAMINER	
111 MONUMENT CIRCLE, SUITE 3700			FEELY, MICHAEL J	
INDIANAPOL	INDIANAPOLIS, IN 46204-5137		ART UNIT	PAPER NUMBER
			1796	
			MAIL DATE	DELIVERY MODE
			09/05/2008	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)
	10/519,251	KIM ET AL.
Office Action Summary	Examiner	Art Unit
	Michael J. Feely	1796
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with the c	correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATION 136(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).
Status		
1) ☐ Responsive to communication(s) filed on 20 A 2a) ☐ This action is FINAL . 2b) ☐ Thi 3) ☐ Since this application is in condition for allowated closed in accordance with the practice under	s action is non-final. ance except for formal matters, pro	
Disposition of Claims		
4) Claim(s) 1-7 is/are pending in the application. 4a) Of the above claim(s) is/are withdra 5) Claim(s) is/are allowed. 6) Claim(s) 1-7 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o Application Papers 9) The specification is objected to by the Examination of the drawing(s) filed on 22 December 2004 is/s	awn from consideration. or election requirement. er.	red to by the Examiner.
Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	e drawing(s) be held in abeyance. Section is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureat* * See the attached detailed Office action for a list	nts have been received. Its have been received in Applicationity documents have been received au (PCT Rule 17.2(a)).	on No ed in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal F 6) Other:	ate

DETAILED ACTION

Pending Claims

Claims 1-7 are pending.

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on August 20, 2008 has been entered.

Claim Rejections - 35 USC § 112

- 2. The following is a quotation of the first paragraph of 35 U.S.C. 112:
 - The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.
- 3. Claims 1-7 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

Independent claim 1 recites the following limitation: applying a heat treatment to the mixture after the mixture has *substantially cured*. The term *substantially cured* is neither defined

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nor supported by the specification. In fact, the specification is silent regarding any *degree of* curing. This is a new matter rejection.

4. Claims 1-7 are rejected under 35 U.S.C. 112, first paragraph, as based on a disclosure which is not enabling. A *liquid phase* base thermoset component is critical or essential to the practice of the invention, but not included in the claim(s). Such an omission is not enabled by the disclosure. See *In re Mayhew*, 527 F.2d 1229, 188 USPO 356 (CCPA 1976).

Based on the method set forth in the specification (bottom of page 2 through page 5), it appears that a liquid phase base thermoset component is required to yield the instantly claimed permanent deformation and compressive residual stress. The Specification fails to provide support for the instantly claimed method featuring a solid phase base thermoset component.

5. The previous rejection of claims 1-7 under 35 U.S.C. 112, first paragraph, as based on a disclosure which is not enabling, *stands*. A *specific sequence of process steps* is critical or essential to the practice of the invention, but not included in the claim(s). Such an omission is not enabled by the disclosure. See *In re Mavhew*, 527 F.2d 1229, 188 USPQ 356 (CCPA 1976).

In order to achieve the instantly claimed *permanent deformation* and *compressive* residual stress, a specific sequence of steps is required, as detailed in the specification (bottom of page 2 through page 5). This is illustrated in Applicant's "MEH" material. The following sequential steps are required:

(a) providing a curable mixture including a liquid phase base thermoset component, a curing agent, and expandable hollow microspheres;

(b) curing the curable mixture at room temperature, forming a cured product;

- (c) heat treating the cured product at a temperature sufficient to cause the expandable hollow microspheres to expand, yielding a permanent deformation of the microspheres;
- (d) cooling the heat treated cured product, wherein compressive residual stress is created in the cured product around the microspheres.

The instantly claimed method fails to disclose a step of curing the curable mixture at room temperature (at a temperature below the activation temperature of the expandable hollow microspheres).

6. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the

subject matter which the applicant regards as his invention.

- 7. Claims 1-7 are rejected under 35 U.S.C. 112, second paragraph, as being incomplete for omitting essential steps, such omission amounting to a gap between the steps. See MPEP § 2172.01. The omitted steps are: *see rejection above in section 5*.
- 8. Claims 1-7 are rejected under 35 U.S.C. 112, second paragraph, as being incomplete for omitting essential structural cooperative relationships of elements, such omission amounting to a gap between the necessary structural connections. See MPEP § 2172.01. The omitted structural cooperative relationships are: (c) a permanent deformation *of* the microspheres; and (d) residual stress created in the cured product *around* the microspheres.

Currently, the instant invention discloses a permanent deformation around the microspheres and compressive residual stress in the mixture. Turning to the Specification (page

4, lines 6-12), Applicant clearly describes a process wherein: (c) heat treatment of the cured product, at a temperature sufficient to cause the expandable hollow microspheres to expand, yields a permanent deformation of the microspheres; and (d) cooling of the heat treated cured product creates compressive residual stress in the cured product around the microspheres.

Claim Language Suggestions

- 9. The following is suggested claim language to overcome the rejections under 35 U.S.C. 112, first and second paragraphs:
- 1. (Currently Amended) A method of manufacturing a thermoset including the sequential steps of: (a) providing a curable mixture including a liquid phase base thermoset component, a curing agent, and expandable hollow microspheres; (b) curing the curable mixture at room temperature, forming a cured product; (c) heat treating the cured product at a temperature sufficient to cause the expandable hollow microspheres to expand, yielding a permanent deformation of the microspheres; and (d) cooling the heat treated cured product, wherein compressive residual stress is created in the cured product around the microspheres.
- 2. (Currently Amended) The method as claimed in claim 1 wherein the liquid phase base thermoset comprises an epoxy resin.
- 3. (Currently Amended) The method as claimed in claim 1 wherein said providing includes adding the curing agent to an initial mixture of the liquid phase base thermoset component and the expandable hollow microspheres.

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4. (Currently Amended) The method as claimed in claim 3 wherein said initial mixture is

heated to reduce the viscosity of the initial mixture before adding the curing agent; and wherein

said heating is at a temperature insufficient to cause the expandable hollow microspheres to

expand.

5. (Currently Amended) The method as claimed in claim 1 further including the step of

pouring the curable mixture into a mould prior to curing.

6. (Currently Amended) The method as claimed in claim 1 wherein the expandable

hollow microspheres comprise a co-polymer shell and gas.

7. (Currently Amended) The method as claimed in claim 4 wherein said heated initial

mixture is allowed to cool before adding the curing agent.

8. (New) The method as claimed in claim 1 wherein the cooled heat treated cured product

is further subjected to a repetition of the sequential steps (c) and (d).

Priority

10. The instant application claims foreign priority to Australian application PS3238, filed

June 27, 2002. The Australian document fails to disclose the essential sequence of steps

(detailed above) with sufficient specificity. This application is also a national stage entry of

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PCT/AU03/00821, filed June 27, 2003. The PCT document does disclose the essential sequence of steps (detailed above) with sufficient specificity. Accordingly, the effective filing date of the instant invention is June 27, 2003.

Conclusion

11. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Morganelli et al. (US 7,047,633) disclose a similar method wherein a thermoset composition with expandable filler is first B-staged. The expandable filler does not expand during the B-stage process. The B-staged material is subsequently heated and cured during a reflow process. This reflow process causes the expandable filler to expand, yielding closed-cell foam. This closed-cell foam appears to feature *permanent deformation* and *compressive residual stress*, due to the sequence of process steps. The one difference between the instant invention and Morganelli et al. is that the expansion step of Morganelli et al. does not appear to take place in a *substantially cured* material.

Wycech (US Pat. No. 4,751,249) and Erb et al. (US 2005/0027025) disclose processes and products related to the instant invention. However, these prior art references do not disclose an expansion step in a *substantially cured* material. Furthermore, these prior art references do not disclose the above-mentioned sequential steps (a)-(d).

Communication

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michael J. Feely whose telephone number is (571)272-1086. The examiner can normally be reached on M-F 8:30 to 5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Harold Y. Pyon can be reached on 571-272-1498. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Michael J Feely/ Primary Examiner, Art Unit 1796

September 2, 2008